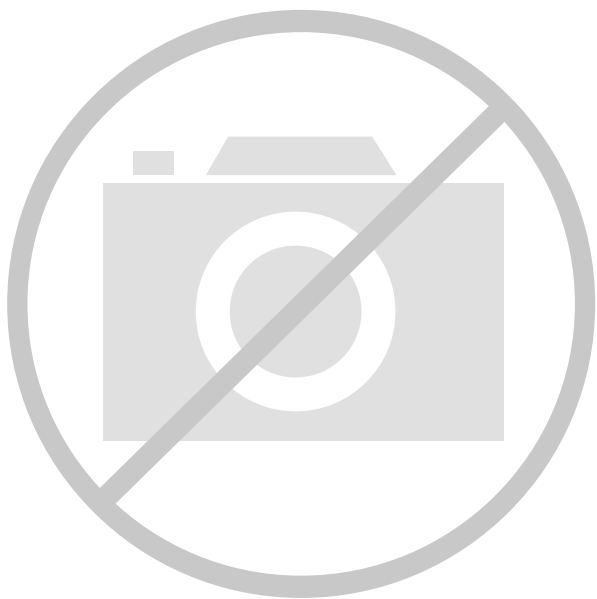




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	84
Number of Logic Elements/Cells	672
Total RAM Bits	-
Number of I/O	120
Number of Gates	8000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	160-BQFP
Supplier Device Package	160-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf8820arc160-2

FLEX 8000 devices contain an optimized microprocessor interface that permits the microprocessor to configure FLEX 8000 devices serially, in parallel, synchronously, or asynchronously. The interface also enables the microprocessor to treat a FLEX 8000 device as memory and configure the device by writing to a virtual memory location, making it very easy for the designer to create configuration software.

The FLEX 8000 family is supported by Altera's MAX+PLUS II development system, a single, integrated package that offers schematic, text—including the Altera Hardware Description Language (AHDL), VHDL, and Verilog HDL—and waveform design entry, compilation and logic synthesis, simulation and timing analysis, and device programming. The MAX+PLUS II software provides EDIF 2 0 0 and 3 0 0, library of parameterized modules (LPM), VHDL, Verilog HDL, and other interfaces for additional design entry and simulation support from other industry-standard PC- and UNIX workstation-based EDA tools. The MAX+PLUS II software runs on Windows-based PCs and Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations.

The MAX+PLUS II software interfaces easily with common gate array EDA tools for synthesis and simulation. For example, the MAX+PLUS II software can generate Verilog HDL files for simulation with tools such as Cadence Verilog-XL. Additionally, the MAX+PLUS II software contains EDA libraries that use device-specific features such as carry chains, which are used for fast counter and arithmetic functions. For instance, the Synopsys Design Compiler library supplied with the MAX+PLUS II development system includes DesignWare functions that are optimized for the FLEX 8000 architecture.



For more information on the MAX+PLUS II software, go to the [*MAX+PLUS II Programmable Logic Development System & Software Data Sheet*](#).

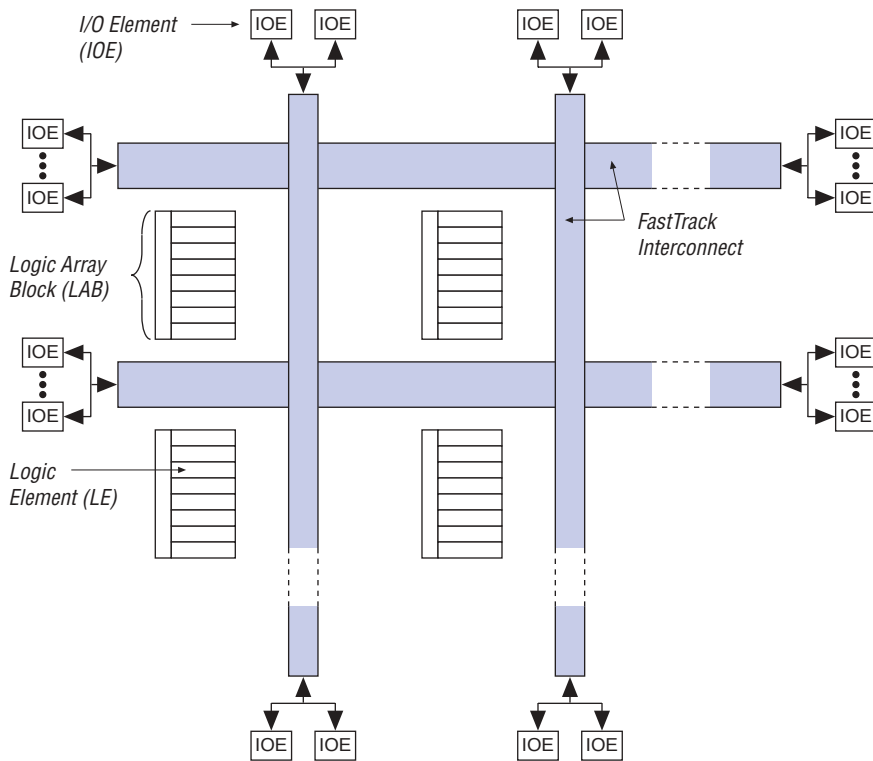
Functional Description

The FLEX 8000 architecture incorporates a large matrix of compact building blocks called logic elements (LEs). Each LE contains a 4-input LUT that provides combinatorial logic capability and a programmable register that offers sequential logic capability. The fine-grained structure of the LE provides highly efficient logic implementation.

Eight LEs are grouped together to form a logic array block (LAB). Each FLEX 8000 LAB is an independent structure with common inputs, interconnections, and control signals. The LAB architecture provides a coarse-grained structure for high device performance and easy routing.

Figure 1 shows a block diagram of the FLEX 8000 architecture. Each group of eight LEs is combined into an LAB; LABs are arranged into rows and columns. The I/O pins are supported by I/O elements (IOEs) located at the ends of rows and columns. Each IOE contains a bidirectional I/O buffer and a flipflop that can be used as either an input or output register.

Figure 1. FLEX 8000 Device Block Diagram



Signal interconnections within FLEX 8000 devices and between device pins are provided by the FastTrack Interconnect, a series of fast, continuous channels that run the entire length and width of the device. IOEs are located at the end of each row (horizontal) and column (vertical) FastTrack Interconnect path.

Logic Array Block

A logic array block (LAB) consists of eight LEs, their associated carry and cascade chains, LAB control signals, and the LAB local interconnect. The LAB provides the coarse-grained structure of the FLEX 8000 architecture. This structure enables FLEX 8000 devices to provide efficient routing, high device utilization, and high performance. Figure 2 shows a block diagram of the FLEX 8000 LAB.

Figure 2. FLEX 8000 Logic Array Block

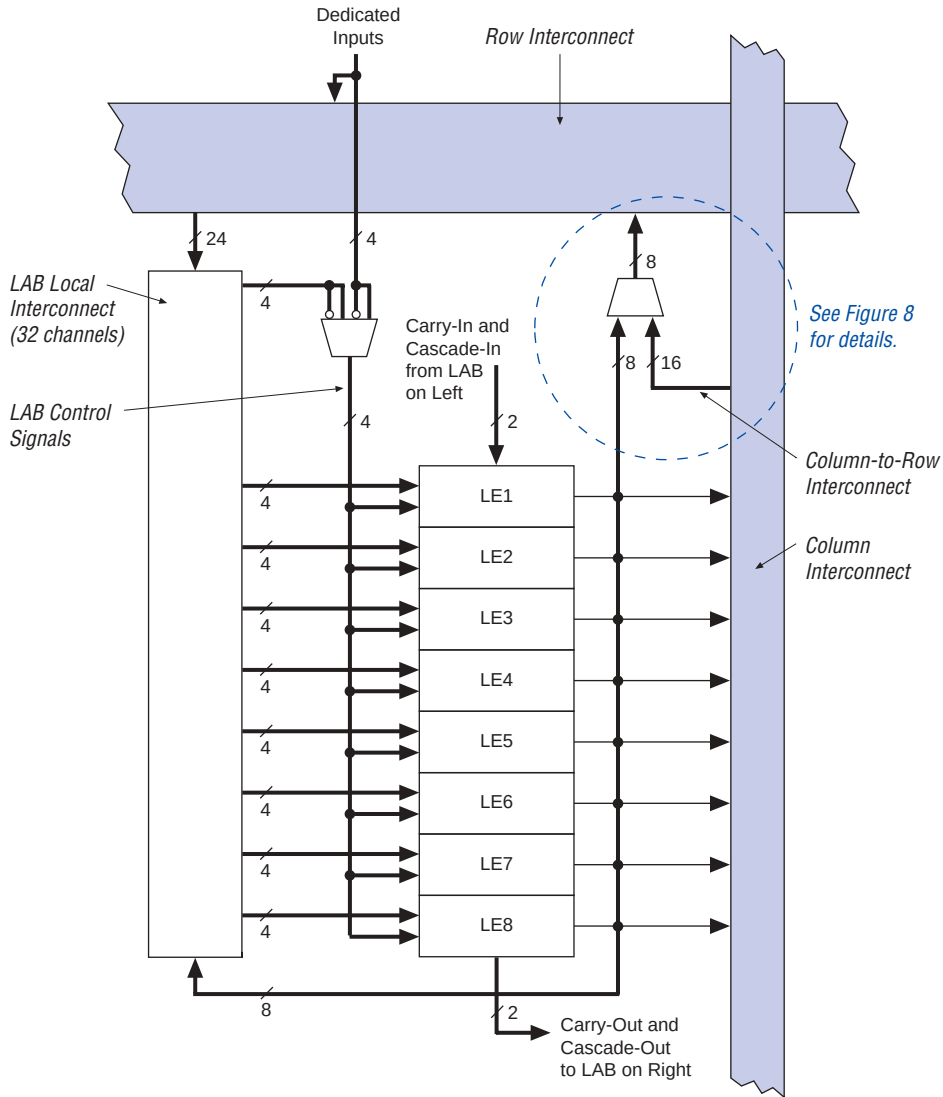
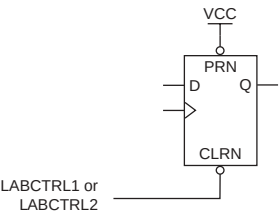
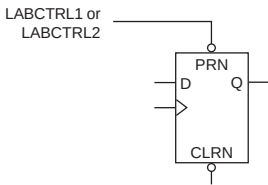


Figure 7. FLEX 8000 LE Asynchronous Clear & Preset Modes

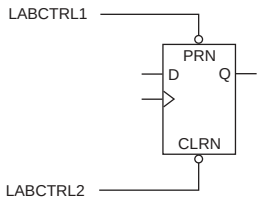
Asynchronous Clear



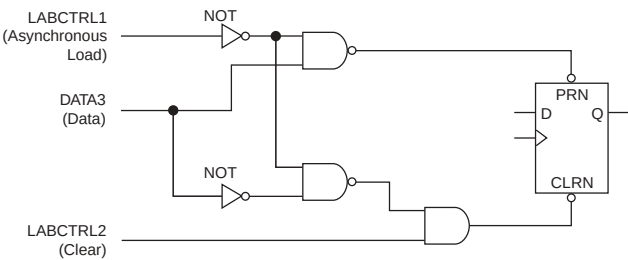
Asynchronous Preset



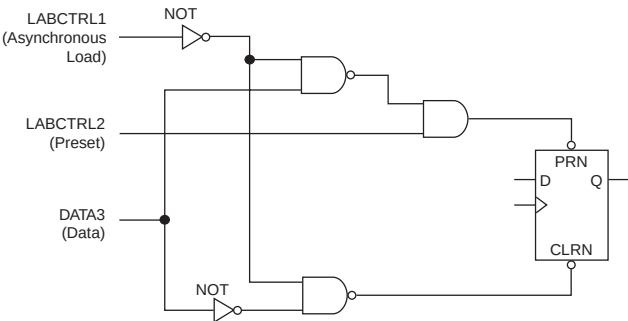
Asynchronous Clear & Preset



Asynchronous Load with Clear



Asynchronous Load with Preset



Asynchronous Load without Clear or Preset

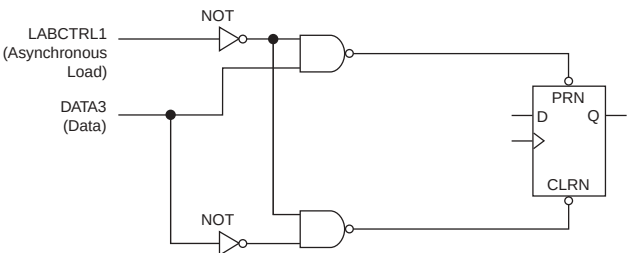


Table 5 lists the source of the peripheral control signal for each FLEX 8000 device by row.

Table 5. Row Sources of FLEX 8000 Peripheral Control Signals						
Peripheral Control Signal	EPF8282A EPF8282AV	EPF8452A	EPF8636A	EPF8820A	EPF81188A	EPF81500A
CLK0	Row A	Row A	Row A	Row A	Row E	Row E
CLK1/OE1	Row B	Row B	Row C	Row C	Row B	Row B
CLR0	Row A	Row A	Row B	Row B	Row F	Row F
CLR1/OE0	Row B	Row B	Row C	Row D	Row C	Row C
OE2	Row A	Row A	Row A	Row A	Row D	Row A
OE3	Row B	Row B	Row B	Row B	Row A	Row A
OE4	–	–	–	–	–	Row B
OE5	–	–	–	–	–	Row C
OE6	–	–	–	–	–	Row D
OE7	–	–	–	–	–	Row D
OE8	–	–	–	–	–	Row E
OE9	–	–	–	–	–	Row F

Output Configuration

This section discusses slew-rate control and MultiVolt I/O interface operation for FLEX 8000 devices.

Slew-Rate Control

The output buffer in each IOE has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A slow slew rate reduces system noise by slowing signal transitions, adding a maximum delay of 3.5 ns. The slow slew-rate setting affects only the falling edge of a signal. The fast slew rate should be used for speed-critical outputs in systems that are adequately protected against noise. Designers can specify the slew rate on a pin-by-pin basis during design entry or assign a default slew rate to all pins on a global basis.



For more information on high-speed system design, go to [Application Note 75 \(High-Speed Board Designs\)](#).

MultiVolt I/O Interface

The FLEX 8000 device architecture supports the MultiVolt I/O interface feature, which allows EPF81500A, EPF81188A, EPF8820A, and EPF8636A devices to interface with systems with differing supply voltages. These devices in all packages—except for EPF8636A devices in 84-pin PLCC packages—can be set for 3.3-V or 5.0-V I/O pin operation. These devices have one set of V_{CC} pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCINT pins must always be connected to a 5.0-V power supply. With a 5.0-V V_{CCINT} level, input voltages are at TTL levels and are therefore compatible with 3.3-V and 5.0-V inputs.

The VCCIO pins can be connected to either a 3.3-V or 5.0-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 5.0-V power supply, the output levels are compatible with 5.0-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with VCCIO levels lower than 4.75 V incur a nominally greater timing delay of t_{OD2} instead of t_{OD1} . See [Table 8 on page 26](#).

IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

The EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices provide JTAG BST circuitry. FLEX 8000 devices with JTAG circuitry support the JTAG instructions shown in [Table 6](#).

Table 6. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Instructions

JTAG Instruction	Description
SAMPLE/PRELOAD	Allows a snapshot of the signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern to be output at the device pins.
EXTEST	Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins.
BYPASS	Places the 1-bit bypass register between the TDI and TD0 pins, which allows the BST data to pass synchronously through the selected device to adjacent devices during normal device operation.

Table 15. FLEX 8000 3.3-V Device DC Operating Conditions *Note (4)*

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{IH}	High-level input voltage		2.0		$V_{CC} + 0.3$	V
V_{IL}	Low-level input voltage		-0.3		0.8	V
V_{OH}	High-level output voltage	$I_{OH} = -0.1$ mA DC (5)	$V_{CC} - 0.2$			V
V_{OL}	Low-level output voltage	$I_{OL} = 4$ mA DC (5)			0.45	V
I_I	Input leakage current	$V_I = V_{CC}$ or ground	-10		10	μ A
I_{OZ}	Tri-state output off-state current	$V_O = V_{CC}$ or ground	-40		40	μ A
I_{CC0}	V_{CC} supply current (standby)	$V_I =$ ground, no load (6)		0.3	10	mA

Table 16. FLEX 8000 3.3-V Device Capacitance *Note (7)*

Symbol	Parameter	Conditions	Min	Max	Unit
C_{IN}	Input capacitance	$V_{IN} = 0$ V, $f = 1.0$ MHz		10	pF
C_{OUT}	Output capacitance	$V_{OUT} = 0$ V, $f = 1.0$ MHz		10	pF

Notes to tables:

- (1) See the *Operating Requirements for Altera Devices Data Sheet*.
- (2) Minimum DC input voltage is -0.3 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 5.3 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) The maximum V_{CC} rise time is 100 ms. V_{CC} must rise monotonically.
- (4) These values are specified in [Table 14 on page 29](#).
- (5) The I_{OH} parameter refers to high-level TTL output current; the I_{OL} parameter refers to low-level TTL output current.
- (6) Typical values are for $T_A = 25^\circ$ C and $V_{CC} = 3.3$ V.
- (7) Capacitance is sample-tested only.

Figure 16 shows the typical output drive characteristics of 5.0-V FLEX 8000 devices. The output driver is compliant with *PCI Local Bus Specification, Revision 2.2*.

Table 17. FLEX 8000 Internal Timing Parameters *Note (1)*

Symbol	Parameter
t_{IOD}	IOE register data delay
t_{IOC}	IOE register control signal delay
t_{IOE}	Output enable delay
t_{IOCO}	IOE register clock-to-output delay
t_{IOCOMB}	IOE combinatorial delay
t_{IOSU}	IOE register setup time before clock; IOE register recovery time after asynchronous clear
t_{IOH}	IOE register hold time after clock
t_{IOCLR}	IOE register clear delay
t_{IN}	Input pad and buffer delay
t_{OD1}	Output buffer and pad delay, slow slew rate = off, $V_{CCIO} = 5.0\text{ V}$, $C1 = 35\text{ pF}$ (2)
t_{OD2}	Output buffer and pad delay, slow slew rate = off, $V_{CCIO} = 3.3\text{ V}$, $C1 = 35\text{ pF}$ (2)
t_{OD3}	Output buffer and pad delay, slow slew rate = on, $C1 = 35\text{ pF}$ (3)
t_{XZ}	Output buffer disable delay, $C1 = 5\text{ pF}$
t_{ZX1}	Output buffer enable delay, slow slew rate = off, $V_{CCIO} = 5.0\text{ V}$, $C1 = 35\text{ pF}$ (2)
t_{ZX2}	Output buffer enable delay, slow slew rate = off, $V_{CCIO} = 3.3\text{ V}$, $C1 = 35\text{ pF}$ (2)
t_{ZX3}	Output buffer enable delay, slow slew rate = on, $C1 = 35\text{ pF}$ (3)

Table 18. FLEX 8000 LE Timing Parameters *Note (1)*

Symbol	Parameter
t_{LUT}	LUT delay for data-in
t_{CLUT}	LUT delay for carry-in
t_{RLUT}	LUT delay for LE register feedback
t_{GATE}	Cascade gate delay
t_{CASC}	Cascade chain routing delay
t_{CICO}	Carry-in to carry-out delay
t_{CGEN}	Data-in to carry-out delay
t_{CGENR}	LE register feedback to carry-out delay
t_C	LE register control signal delay
t_{CH}	LE register clock high time
t_{CL}	LE register clock low time
t_{CO}	LE register clock-to-output delay
t_{COMB}	Combinatorial delay
t_{SU}	LE register setup time before clock; LE register recovery time after asynchronous preset, clear, or load
t_H	LE register hold time after clock
t_{PRE}	LE register preset delay
t_{CLR}	LE register clear delay

Table 24. EPF8282A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_C		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_H	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 25. EPF8282A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t _{DRR}		15.8		19.8		24.8	ns
t _{ODH}	1.0		1.0		1.0		ns

Table 28. EPF8282AV Logic Element Timing Parameters

Symbol	Speed Grade				Unit
	A-3		A-4		
	Min	Max	Min	Max	
t_{LUT}		3.2		7.3	ns
t_{CLUT}		0.0		1.4	ns
t_{RLUT}		1.5		5.1	ns
t_{GATE}		0.0		0.0	ns
t_{CASC}		0.9		2.8	ns
t_{CICO}		0.6		1.5	ns
t_{CGEN}		0.7		2.2	ns
t_{CGENR}		1.5		3.7	ns
t_C		2.5		4.7	ns
t_{CH}	4.0		6.0		ns
t_{CL}	4.0		6.0		ns
t_{CO}		0.6		0.9	ns
t_{COMB}		0.6		0.9	ns
t_{SU}	1.2		2.4		ns
t_H	1.5		4.6		ns
t_{PRE}		0.8		1.3	ns
t_{CLR}		0.8		1.3	ns

Table 29. EPF8282AV External Timing Parameters

Symbol	Speed Grade				Unit
	A-3		A-4		
	Min	Max	Min	Max	
t _{DDR}		24.8		50.1	ns
t _{ODH}	1.0		1.0		ns

Table 38. EPF8820A I/O Element Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{IOD}		0.7		0.8		0.9	ns
t_{IOC}		1.7		1.8		1.9	ns
t_{IOE}		1.7		1.8		1.9	ns
t_{IOCO}		1.0		1.0		1.0	ns
t_{IOCOMB}		0.3		0.2		0.1	ns
t_{IOSU}	1.4		1.6		1.8		ns
t_{IOH}	0.0		0.0		0.0		ns
t_{IOCLR}		1.2		1.2		1.2	ns
t_{IN}		1.5		1.6		1.7	ns
t_{OD1}		1.1		1.4		1.7	ns
t_{OD2}		1.6		1.9		2.2	ns
t_{OD3}		4.6		4.9		5.2	ns
t_{XZ}		1.4		1.6		1.8	ns
t_{ZX1}		1.4		1.6		1.8	ns
t_{ZX2}		1.9		2.1		2.3	ns
t_{ZX3}		4.9		5.1		5.3	ns

Table 39. EPF8820A Interconnect Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
$t_{LABCASC}$		0.3		0.3		0.4	ns
$t_{LABCARRY}$		0.3		0.3		0.4	ns
t_{LOCAL}		0.5		0.6		0.8	ns
t_{ROW}		5.0		5.0		5.0	ns
t_{COL}		3.0		3.0		3.0	ns
t_{DIN_C}		5.0		5.0		5.5	ns
t_{DIN_D}		7.0		7.0		7.5	ns
t_{DIN_IO}		5.0		5.0		5.5	ns

Table 40. EPF8820A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_C		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_H	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 41. EPF8820A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t _{DRR}		16.0		20.0		25.0	ns
t _{ODH}	1.0		1.0		1.0		ns

Table 44. EPF81188A LE Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t_{LUT}		2.0		2.5		3.2	ns
t_{CLUT}		0.0		0.0		0.0	ns
t_{RLUT}		0.9		1.1		1.5	ns
t_{GATE}		0.0		0.0		0.0	ns
t_{CASC}		0.6		0.7		0.9	ns
t_{CICO}		0.4		0.5		0.6	ns
t_{CGEN}		0.4		0.5		0.7	ns
t_{CGENR}		0.9		1.1		1.5	ns
t_C		1.6		2.0		2.5	ns
t_{CH}	4.0		4.0		4.0		ns
t_{CL}	4.0		4.0		4.0		ns
t_{CO}		0.4		0.5		0.6	ns
t_{COMB}		0.4		0.5		0.6	ns
t_{SU}	0.8		1.1		1.2		ns
t_H	0.9		1.1		1.5		ns
t_{PRE}		0.6		0.7		0.8	ns
t_{CLR}		0.6		0.7		0.8	ns

Table 45. EPF81188A External Timing Parameters

Symbol	Speed Grade						Unit
	A-2		A-3		A-4		
	Min	Max	Min	Max	Min	Max	
t _{DRR}		16.0		20.0		25.0	ns
t _{ODH}	1.0		1.0		1.0		ns

Operating Modes

The FLEX 8000 architecture uses SRAM elements that require configuration data to be loaded whenever the device powers up and begins operation. The process of physically loading the SRAM programming data into the device is called *configuration*. During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. The I/O pins are tri-stated during power-up, and before and during configuration. The configuration and initialization processes together are called *command mode*; normal device operation is called *user mode*.

SRAM elements allow FLEX 8000 devices to be reconfigured in-circuit with new programming data that is loaded into the device. Real-time reconfiguration is performed by forcing the device into command mode with a device pin, loading different programming data, reinitializing the device, and resuming user-mode operation. The entire reconfiguration process requires less than 100 ms and can be used to dynamically reconfigure an entire system. In-field upgrades can be performed by distributing new configuration files.

Configuration Schemes

The configuration data for a FLEX 8000 device can be loaded with one of six configuration schemes, chosen on the basis of the target application. Both active and passive schemes are available. In the active configuration schemes, the FLEX 8000 device functions as the controller, directing the loading operation, controlling external configuration devices, and completing the loading process. The clock source for all active configuration schemes is an oscillator on the FLEX 8000 device that operates between 2 MHz and 6 MHz. In the passive configuration schemes, an external controller guides the FLEX 8000 device. [Table 51](#) shows the data source for each of the six configuration schemes.

Table 51. Data Source for Configuration		
Configuration Scheme	Acronym	Data Source
Active serial	AS	Altera configuration device
Active parallel up	APU	Parallel configuration device
Active parallel down	APD	Parallel configuration device
Passive serial	PS	Serial data path
Passive parallel synchronous	PPS	Intelligent host
Passive parallel asynchronous	PPA	Intelligent host

Device Pin-Outs

Tables 52 through 54 show the pin names and numbers for the dedicated pins in each FLEX 8000 device package.

Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 1 of 3)

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
nSP (2)	75	75	75	76	110	R1	1
MSEL0 (2)	74	74	74	75	109	P2	2
MSEL1 (2)	53	53	51	51	72	A1	44
nSTATUS (2)	32	32	24	25	37	C13	82
nCONFIG (2)	33	33	25	26	38	A15	81
DCLK (2)	10	10	100	100	143	P14	125
CONF_DONE (2)	11	11	1	1	144	N13	124
nWS	30	30	22	23	33	F13	87
nRS	48	48	42	45	31	C6	89
RDCLK	49	49	45	46	12	B5	110
nCS	29	29	21	22	4	D15	118
CS	28	28	19	21	3	E15	121
RDYnBUSY	77	77	77	78	20	P3	100
CLKUSR	50	50	47	47	13	C5	107
ADD17	51	51	49	48	75	B4	40
ADD16	36	55	28	54	76	E2	39
ADD15	56	56	55	55	77	D1	38
ADD14	57	57	57	57	78	E1	37
ADD13	58	58	58	58	79	F3	36
ADD12	60	60	59	60	83	F2	32
ADD11	61	61	60	61	85	F1	30
ADD10	62	62	61	62	87	G2	28
ADD9	63	63	62	64	89	G1	26
ADD8	64	64	64	65	92	H1	22
ADD7	65	65	65	66	94	H2	20
ADD6	66	66	66	67	95	J1	18
ADD5	67	67	67	68	97	J2	16
ADD4	69	69	68	70	102	K2	11
ADD3	70	70	69	71	103	K1	10
ADD2	71	71	71	72	104	K3	8
ADD1	76	72	76	73	105	M1	7

Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 2 of 3)

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
ADD0	78	76	78	77	106	N3	6
DATA7	3	2	90	89	131	P8	140
DATA6	4	4	91	91	132	P10	139
DATA5	6	6	92	95	133	R12	138
DATA4	7	7	95	96	134	R13	136
DATA3	8	8	97	97	135	P13	135
DATA2	9	9	99	98	137	R14	133
DATA1	13	13	4	4	138	N15	132
DATA0	14	14	5	5	140	K13	129
SDOUT (3)	79	78	79	79	23	P4	97
TDI (4)	55	45 (5)	54	—	96	—	17
TD0 (4)	27	27 (5)	18	—	18	—	102
TCK (4), (6)	72	44 (5)	72	—	88	—	27
TMS (4)	20	43 (5)	11	—	86	—	29
TRST (7)	52	52 (8)	50	—	71	—	45
Dedicated Inputs (10)	12, 31, 54, 73	12, 31, 54, 73	3, 23, 53, 73	3, 24, 53, 74	9, 26, 82, 99	C3, D14, N2, R15	14, 33, 94, 113
VCCINT	17, 38, 59, 80	17, 38, 59, 80	6, 20, 37, 56, 70, 87	9, 32, 49, 59, 82	8, 28, 70, 90, 111	B2, C4, D3, D8, D12, G3, G12, H4, H13, J3, J12, M4, M7, M9, M13, N12	3, 24, 46, 92, 114, 160
VCCIO	—	—	—	—	16, 40, 60, 69, 91, 112, 122, 141	—	23, 47, 57, 69, 79, 104, 127, 137, 149, 159

Table 52. FLEX 8000 84-, 100-, 144- & 160-Pin Package Pin-Outs (Part 3 of 3)

Pin Name	84-Pin PLCC EPF8282A	84-Pin PLCC EPF8452A EPF8636A	100-Pin TQFP EPF8282A EPF8282AV	100-Pin TQFP EPF8452A	144-Pin TQFP EPF8820A	160-Pin PGA EPF8452A	160-Pin PQFP EPF8820A (1)
GND	5, 26, 47, 68	5, 26, 47, 68	2, 13, 30, 44, 52, 63, 80, 94	19, 44, 69, 94	7, 17, 27, 39, 54, 80, 81, 100, 101, 128, 142	C12, D4, D7, D9, D13, G4, G13, H3, H12, J4, J13, L1, M3, M8, M12, M15, N4	12, 13, 34, 35, 51, 63, 75, 80, 83, 93, 103, 115, 126, 131, 143, 155
No Connect (N.C.)	—	—	—	2, 6, 13, 30, 37, 42, 43, 50, 52, 56, 63, 80, 87, 92, 93, 99	—	—	—
Total User I/O Pins (9)	64	64	74	64	108	116	116

Table 53. FLEX 8000 160-, 192- & 208-Pin Package Pin-Outs (Part 1 of 2)

Pin Name	160-Pin PQFP EPF8452A	160-Pin PQFP EPF8636A	192-Pin PGA EPF8636A EPF8820A	208-Pin PQFP EPF8636A (1)	208-Pin PQFP EPF8820A (1)	208-Pin PQFP EPF81188A (1)
nSP (2)	120	1	R15	207	207	5
MSEL0 (2)	117	3	T15	4	4	21
MSEL1 (2)	84	38	T3	49	49	33
nSTATUS (2)	37	83	B3	108	108	124
nCONFIG (2)	40	81	C3	103	103	107
DCLK (2)	1	120	C15	158	158	154
CONF_DONE (2)	4	118	B15	153	153	138
nWS	30	89	C5	114	114	118
nRS	71	50	B5	66	116	121
RDCLK	73	48	C11	64	137	137
nCS	29	91	B13	116	145	142
CS	27	93	A16	118	148	144
RDYnBUSY	125	155	A8	201	127	128
CLKUSR	76	44	A10	59	134	134
ADD17	78	43	R5	57	43	46
ADD16	91	33	U3	43	42	45
ADD15	92	31	T5	41	41	44
ADD14	94	29	U4	39	40	39
ADD13	95	27	R6	37	39	37
ADD12	96	24	T6	31	35	36
ADD11	97	23	R7	30	33	31
ADD10	98	22	T7	29	31	30
ADD9	99	21	T8	28	29	29
ADD8	101	20	U9	24	25	26
ADD7	102	19	U10	23	23	25
ADD6	103	18	U11	22	21	24
ADD5	104	17	U12	21	19	18
ADD4	105	13	R12	14	14	17
ADD3	106	11	U14	12	13	16
ADD2	109	9	U15	10	11	10
ADD1	110	7	R13	8	10	9
ADD0	123	157	U16	203	9	8
DATA7	144	137	H17	178	178	177
DATA6	150	132	G17	172	176	175
DATA5	152	129	F17	169	174	172

Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 1 of 3)

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
nSP (2)	A15	C14	237	237	W1	304
MSEL0 (2)	B14	G15	21	19	N1	26
MSEL1 (2)	R15	L15	40	38	H3	51
nSTATUS (2)	P2	L3	141	142	G19	178
nCONFIG (2)	R1	R4	117	120	B18	152
DCLK (2)	B2	C4	184	183	U18	230
CONF_DONE (2)	A1	G3	160	161	M16	204
nWS	L4	P1	133	134	F18	167
nRS	K5	N1	137	138	G18	171
RDCLK	F1	G2	158	159	M17	202
nCS	D1	E2	166	167	N16	212
CS	C1	E3	169	170	N18	215
RDYnBUSY	J3	K2	146	147	J17	183
CLKUSR	G2	H2	155	156	K19	199
ADD17	M14	R15	58	56	E3	73
ADD16	L12	T17	56	54	E2	71
ADD15	M15	P15	54	52	F4	69
ADD14	L13	M14	47	45	G1	60
ADD13	L14	M15	45	43	H2	58
ADD12	K13	M16	43	41	H1	56
ADD11	K15	K15	36	34	J3	47
ADD10	J13	K17	34	32	K3	45
ADD9	J15	J14	32	30	K4	43
ADD8	G14	J15	29	27	L1	34
ADD7	G13	H17	27	25	L2	32
ADD6	G11	H15	25	23	M1	30
ADD5	F14	F16	18	16	N2	20
ADD4	E13	F15	16	14	N3	18
ADD3	D15	F14	14	12	N4	16
ADD2	D14	D15	7	5	U1	8
ADD1	E12	B17	5	3	U2	6
ADD0	C15	C15	3	1	V1	4
DATA7	A7	A7	205	199	W13	254
DATA6	D7	D8	203	197	W14	252
DATA5	A6	B7	200	196	W15	250

Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 2 of 3)

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
DATA4	A5	C7	198	194	W16	248
DATA3	B5	D7	196	193	W17	246
DATA2	E6	B5	194	190	V16	243
DATA1	D5	A3	191	189	U16	241
DATA0	C4	A2	189	187	V17	239
SDOUT (3)	K1	N2	135	136	F19	169
TDI	F15 (4)	–	–	63 (14)	B1 (14)	80 (14)
TDO	J2 (4)	–	–	117	C17	149
TCK (6)	J14 (4)	–	–	116 (14)	A19 (14)	148 (14)
TMS	J12 (4)	–	–	64 (14)	C2 (14)	81 (14)
TRST (7)	P14	–	–	115 (14)	A18 (14)	145 (14)
Dedicated Inputs (10)	F4, L1, K12, E15	C1, C17, R1, R17	10, 51, 130, 171	8, 49, 131, 172	F1, F16, P3, P19	12, 64, 164, 217
VCCINT (5.0 V)	F5, F10, E1, L2, K4, M12, P15, H13, H14, B15, C13	E4, H4, L4, P12, L14, H14, E14, R14, U1	20, 42, 64, 66, 114, 128, 150, 172, 236	18, 40, 60, 62, 91, 114, 129, 151, 173, 209, 236	B17, D3, D15, E8, E10, E12, E14, R7, R9, R11, R13, R14, T14	24, 54, 77, 144, 79, 115, 162, 191, 218, 266, 301
VCCIO (5.0 V or 3.3 V)	H3, H2, P6, R6, P10, N10, R14, N13, H15, H12, D12, A14, B10, A10, B6, C6, A2, C3, M4, R2	N10, M13, M5, K13, K5, H13, H5, F5, E10, E8, N8, F13	19, 41, 65, 81, 99, 116, 140, 162, 186, 202, 220, 235	17, 39, 61, 78, 94, 108, 130, 152, 174, 191, 205, 221, 235	D14, E7, E9, E11, E13, R6, R8, R10, R12, T13, T15	22, 53, 78, 99, 119, 137, 163, 193, 220, 244, 262, 282, 300